ABBOGIATION CONNECTING LECTRONICS INDUSTRIESS INDUSTRIESS INDUSTRIESS	burn, Illinois. All rights reserve	d under both This	is document el parts, the	is a declarati declaration e	on of the su ncompasses	bstances v all lower	vithin the manufactur level materials for w	rer listed it which the m	em. Note: i anufacturer	f the item is an as has engineering	sembly with lower responsibility.	
1752-21.1 IPC Web Site for Information or http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Type   http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					s and Mfg Information			
Supplier Information												
Company name*		Unique ID Authority				Response Date*						
onsemi				2025-07-12								
Contact Name	zt Name Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards		NA	NA				Product-Env-Stewards@onsemi.com					
Authorized Representative*	epresentative* Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance		NA		A				Product	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Ite	m Number Mfr Item Nam	Mfr Item Name		ffective Date	Version	М	Manufacturing Site		Veight*	UOM	Unit Type	
NB6L1	1SMNR2G HF LVDS FAI	NOUT BUFF/TRANS	T BUFF/TRANS 20		2025-07-12		MY1		23.69 1		Each	
Manufacturing Proccess Information					1	I				1	I	
Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Ra	ating	Peak Proce	Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycl		les			
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)	CU Alloy	1		260		С	30	secon	is 3			
Comments				•			•		•			
evel 1 - maximum time at peak temperature during s	oldering is 10-30 seconds											
For more information regarding material compositio	1 please refer to page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.25	mg	Supplier	Silicon (Si)	7440-21-3		0.25	mg
Die Attach	0.65	mg	Supplier	Silver (Ag)	7440-22-4		0.4875	mg
			Supplier	Epoxy resins	129915-35-1		0.1625	mg
Lead Frame	10.08	mg	Supplier	Tin (Sn)	7440-31-5		0.0252	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0222	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0252	mg
			Supplier	Copper (Cu)	7440-50-8		10.0074	mg
Mold Compound-Black	12.09	mg		Epoxy resin	proprietary data		0.5682	mg
			Supplier	Phenol Resin	Proprietary Data		0.5682	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0121	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.9415	mg
Plating	0.48	mg	Supplier	Palladium (Pd)	7440-05-3		0.0115	mg
			В	Nickel (Ni)	7440-02-0		0.4224	mg
			Supplier	Gold (Au)	7440-57-5		0.0461	mg
Wire Bond - Au	0.14	mg	Supplier	Gold (Au)	7440-57-5		0.14	mg